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## Migrating from Bluetooth® LE stack v3.x to v4.x on STM32WB0 MCUs

### Introduction

This document describes the modifications from Bluetooth® LE stack v3.x to v4.x on STM32WB0 series MCUs, and the related implications when migrating an application from Bluetooth® LE stack v3.x to Bluetooth® LE stack v4.x.

It provides the list of Bluetooth® LE stack v4.x changes:

- Bluetooth® LE stack modular configurations options
- Bluetooth® LE stack initialization parameters
- Bluetooth® LE stack error codes
- Bluetooth® LE stack commands
- Bluetooth® LE stack events

Further, it details the new Bluetooth® LE security framework in terms of redefined and new commands and events introduced within the Bluetooth® LE stack v4.x.

*Note: Bluetooth® LE stack v4.x is provided within the STM32\_BLE middleware included on STM32CubeWB0 SW package. The Bluetooth® LE stack v3.x is provided within the STSW-BNRGLP-DK SW package.*

## 1 General information

This document applies to STM32WB0 Arm®-based MCUs.

For information on Bluetooth®, refer to the [www.bluetooth.com](http://www.bluetooth.com) website

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## 2 Reference documents

N°	Documents
[1]	How to build a Bluetooth® LE application with STM32WB0 MCUs (AN5977)
[2]	<a href="https://wiki.st.com/stm32mcu/wiki/Utility:Sequencer">https://wiki.st.com/stm32mcu/wiki/Utility:Sequencer</a>

## 3 Modular configurations and initialization of Bluetooth® LE stack v4.x vs v3.x

### 3.1 Bluetooth® LE stack modular configuration options

Table 1 describes the available modular configurations options on Bluetooth® LE stack v3.x and v4.x that may be selected by user based on the specific application scenario:

**Table 1. Bluetooth® LE stack modular configurations**

Modular configuration option	3.x <sup>(1)</sup>	4.x <sup>(2)</sup>	Associated symbol on Bluetooth® LE stack v4.x (to be set to 0 or 1)
Controller privacy	Yes	Yes	CFG_BLE_CONTROLLER_PRIVACY_ENABLED
Controller scan role	Yes	Yes	CONTROLLER_SCAN_ENABLED <sup>(3)</sup>
LE secure connections	Yes	Yes	CFG_BLE_SECURE_CONNECTIONS_ENABLED
Controller data length extension	Yes	Yes	CFG_BLE_CONTROLLER_DATA_LENGTH_EXTENSION_ENABLED
Controller LE 2M/Coded PHY	Yes	Yes	CFG_BLE_CONTROLLER_2M_CODED_PHY_ENABLED
Controller extended ADV/SCAN	Yes	Yes	CFG_BLE_CONTROLLER_EXT_ADV_SCAN_ENABLED
L2CAP connection oriented channels	Yes	Yes	CFG_BLE_L2CAP_COS_ENABLED
Controller periodic advertising	Yes	Yes	CFG_BLE_CONTROLLER_PERIODIC_ADV_ENABLED
Enhanced ATT	Yes	No	-
Controller periodic advertising with responses (PAWR)	No	Yes	CFG_BLE_CONTROLLER_PERIODIC_ADV_WR_ENABLED
Controller power control & path Loss	Yes	Yes	CFG_BLE_CONTROLLER_POWER_CONTROL_ENABLED
Connections support	Yes	Yes	CFG_BLE_CONNECTION_ENABLED
Controller LE Channel classification	Yes	Yes	CFG_BLE_CONTROLLER_CHAN_CLASS_ENABLED
Controller BIS support Broadcast isochronous streams	Yes	Yes	CFG_BLE_CONTROLLER_BIS_ENABLED
Controller CIS support Connected isochronous streams	Yes	Yes	CFG_BLE_CONTROLLER_CIS_ENABLED
Connection subrating	Yes	Yes	CFG_BLE_CONNECTION_SUBRATING_ENABLED
Controller constant tone extension <sup>(4)</sup>	Yes	Yes	CFG_BLE_CONTROLLER_CTE_ENABLED

1. Bluetooth® LE stack v3.2/3.2a.
2. Bluetooth® LE stack v4.0 is the current version
3. Renamed option name on Bluetooth® LE stack v4.x
4. Supported only by STM32WB05xZ and STM32WB09xE devices.

In the context of STM32CubeWB0 software package, the Bluetooth® LE modular configurations options are defined within the file `app_conf.h` available on each Bluetooth® LE application under `Core\Inc` folder.

This file is generated by the CubeMX tool, when building an STM32\_BLE (STM32WB0 Bluetooth® LE middleware) application. User can select the Bluetooth® LE stack modular configuration options through the related CubeMX tool, in the STM32\_BLE Application configuration - Modular Options tab.

## 3.2 Bluetooth® LE stack initialization parameters

The Bluetooth® LE stack v4.x stack initialization parameters have been modified to support new input parameters requested for handling the periodic advertising with response (PAwR) feature and the redesigned isochronous channel feature.

Table 2 describes the available Bluetooth® LE stack initialization parameters on both Bluetooth® LE stack v3.x and v4.x.

**Table 2. Bluetooth® LE stack initialization parameters**

Type	Field/Parameter name	3.x <sup>(1)</sup>	4.x	Description
uint8_t*	BLEStartRamAddress	Yes	Yes	Start address of the RAM buffer for GATT database allocated according to TOTAL_BUFFER_SIZE (32-bit aligned RAM area).
uint32_t	TotalBufferSize	Yes	Yes	TOTAL_BUFFER_SIZE return value, used to check the MACRO correctness.
uint16_t	NumAttrRecords	Yes	Yes	Maximum number of attributes that can be stored in the GATT database.
uint8_t	MaxNumOfClientProcs	Yes	Yes	Maximum number of concurrent client procedures. This value shall be less or equal to NumOfLinks.
uint8_t	NumOfRadioTasks <sup>(2)</sup>	Yes	Yes	Maximum number of simultaneous radio tasks. Radio controllers support up to 128 simultaneous radio tasks, but the actual usable max value depends on the available device RAM (NUM_LINKS used in the calculation of BLE_STACK_TOTAL_BUFFER_SIZE).
uint16_t	NumOfEATTChannels	Yes	Yes	Maximum number of simultaneous EATT active channels
uint16_t	NumBlockCount	Yes	Yes	Number of allocated memory blocks.
uint16_t	ATT_MTU	Yes	Yes	Maximum supported ATT_MTU size.
uint32_t	MaxConnEventLength	Yes	Yes	Maximum duration of the connection event when the device is in target mode in units of 625/256 us (~2.44 us).
uint16_t	SleepClockAccuracy	Yes	Yes	Sleep clock accuracy (ppm value).
uint8_t	NumOfAdvDataSet	Yes	Yes	Maximum number of advertising datasets. It is valid only when the advertising extension feature is enabled.
uint8_t	NumOfSubeventsPAwR	No	Yes	Maximum number of periodic advertising with responses subevents.
uint8_t	MaxPAwRSubeventDataCount	No	Yes	Maximum number of periodic advertising with responses subevents that data can be requested.
uint8_t	NumOfAuxScanSlots	Yes	Yes	Maximum number of slots for scanning on the secondary advertising channel, valid only when the advertising extension feature is enabled
uint8_t	NumOfSyncSlots	Yes	Yes	Maximum number of slots for synchronizing, valid only when periodic advertising and synchronizing feature is enabled
uint8_t	FilterAcceptListSizeLog2 <sup>(3)</sup>	Yes	Yes	Two logarithms of the filter/resolving list size.
uint16_t	L2CAP_MPS	Yes	Yes	The maximum size of payload data in octets that the L2CAP layer entity can accept.
uint8_t	L2CAP_NumChannels	Yes	Yes	Maximum number of channels in LE credit based flow control mode.
uint8_t	CTE_MaxNumAntennaIDs	Yes	Yes	Maximum number of antenna IDs in the antenna pattern used in CTE connection oriented mode
uint8_t	CTE_MaxNumIQSamples	Yes	Yes	Maximum number of IQ samples in the buffer used in CTE connection oriented mode.
uint8_t	NumOfSyncBIG	No	Yes	Maximum number of ISO synchronizer groups
uint8_t	NumOfBrC BIG	No	Yes	Maximum number of ISO broadcaster groups
uint8_t	NumOfSyncBIS	No	Yes	Maximum number of ISO synchronizer streams
uint8_t	NumOfBrC BIS	No	Yes	Maximum number of ISO broadcaster streams
uint8_t	NumOfCIG	No	Yes	Maximum number of connected isochronous groups

Type	Field/Parameter name	3.x <sup>(1)</sup>	4.x	Description
				(default = 2 if CIG is enabled; 0 if not enabled)
uint8_t	NumOfCIS	No	Yes	Maximum number of connected isochronous streams (default = 2 if CIG is enabled; 0 if not enabled)
uint8_t	ExtraLLProcedureContexts <sup>(4)</sup>	No	Yes	Maximum number of simultaneous link layer procedures that can be managed, in addition to the minimum required by the stack.
uint16	isr0_fifo_size	Yes	Yes	Size of the internal FIFO used for critical controller events produced by the ISR (for example, Rx data packets)
uint16	isr1_fifo_size	Yes	Yes	Size of the internal FIFO used for noncritical controller events produced by the ISR (for example, advertising or IQ sampling reports)
uint16	user_fifo_size	Yes	Yes	Size of the internal FIFO used for controller and host events produced outside the ISR

1. Bluetooth® LE stack v3.2/3.2a.

2. On Bluetooth® LE stack v3.x this parameter is called NumOfLinks

3. On Bluetooth® LE stack v3.x this parameter is called WhiteListSizeLog2

4. Bluetooth® LE stack v4.1 or later.

In the context of STM32CubeWB0 software package, the Bluetooth® LE stack initialization parameters are defined within the file `app_conf.h` available on each Bluetooth® LE application under `Core\Inc` folder.

This file is generated by the CubeMX tool, when building an STM32\_BLE (STM32WB0 Bluetooth® LE middleware) application. User can select the Bluetooth® LE stack initialization parameter through the related CubeMX tool, in the STM32\_BLE Application configuration - BLE stack tab.

## 4 Bluetooth® LE stack v4.x command and event modifications

This section lists all the modifications that directly affected the commands and events of the Bluetooth® LE stack v4.x.

### 4.1 New standard controller error codes

The following error codes in Table 3 have been added to the `ble_status.h` definitions because they are used by the new features supported.

The documentation can be found in *Bluetooth Specification v.5.4, Vol. 1, Part F, Controller Error Codes*.

**Table 3. Error codes**

Controller error code (v4.x)	Value
BLE_ERROR_TOO_LATE (required by periodic advertising with responses)	(0x46)
BLE_ERROR_TOO_EARLY (required by periodic advertising with responses)	(0x47)

### 4.2 Bluetooth® LE stack v4.x commands

#### 4.2.1 New periodic advertising with response commands

**Table 4. New commands related to PAwR added by Bluetooth® LE stack v4.x**

Command name (v4.x)	Short description
hci_le_extended_create_connection_v2	See <i>Bluetooth Spec v.5.4, Vol. 4, Part E, HCI, Sec. 7.8</i>
hci_le_set_extended_advertising_parameters_v2	
hci_le_set_periodic_sync_subevent	
hci_le_extended_create_connection_v2	
hci_le_set_periodic_advertising_parameters_v2	
hci_le_set_periodic_advertising_subevent_data	
hci_le_set_periodic_advertising_response_data	Specific commands used for advertising data management.
ll_set_periodic_advertising_subevent_data_ptr	
ll_set_periodic_advertising_response_data_ptr	Vendor specific, currently stubbed to void.
aci_gap_create_periodic_advertising_connection	

Table 5 details the list of vendor specific commands added to the Bluetooth® LE stack v4.x.

**Table 5. List of new vendor-specific commands introduced by Bluetooth® LE stack v4.x**

Command name (v4.x)	Short description
aci_gap_decrypt_adv_data, aci_gap_decrypt_adv_data_nwk <sup>(1)</sup>	This command is used by the application to decrypt data used in advertising packets.
aci_gap_encrypt_adv_data, aci_gap_encrypt_adv_data_nwk <sup>(1)</sup>	This command is used by the application to encrypt data used in advertising packets.
aci_gap_pairing_resp	This command shall be given in response to an <code>aci_gap_paring_event</code> , to allow or reject either the pairing request from the Central or the security request from the peripheral.
aci_gap_profile_init	Command to be issued to initialize GAP Profile after the <code>aci_gap_init()</code> call.

Command name (v4.x)	Short description
aci_gatt_clt_add_subscription_security_level	Set a minimum security level to accept server-initiated packets (notification, indication, multiple notifications).
aci_l2cap_cos_flow_control_credits_ind	Command to be issued when the device can receive additional K-frames in LE credit-based flow control mode.
aci_l2cap_cos_connection_req	Create and configure an L2CAP channel between two devices using either LE Credit Based Flow Control Mode or Enhanced Credit Based Flow Control Mode.
aci_l2cap_cos_connection_resp	Command to be sent to respond to a request to open an L2CAP channel using LE Credit based Flow Control or Enhanced Credit Based Flow Control Mode.
aci_l2cap_cos_sdu_data_transmit	Function to be called to send an SDU using an L2CAP channel in LE Credit Based Flow Control mode or Enhanced Credit Based Flow Control Mode.
aci_l2cap_cos_reconfigure_req	Command to send an L2CAP_CREDIT_BASED_RECONFIGURE_REQ packet in order to request to change its receive MTU or MPS values compared to when the channels were created or last reconfigured.
aci_l2cap_cos_reconfigure_resp	Command to send an L2CAP_CREDIT_BASED_RECONFIGURE_RSP packet in order to respond to an incoming L2CAP_CREDIT_BASED_RECONFIGURE_REQ.

1. Commands available on network coprocessor framework.

## 4.2.2 Bluetooth® LE stack v4.x renamed commands

**Table 6. List of commands renamed on Bluetooth® LE stack v4.x vs v3.x**

New command name (v4.x)	Command name (v3.x)
hci_le_read_advertising_physical_channel_tx_power	hci_le_read_advertising_channel_tx_power
hci_le_read_filter_accept_list_size	hci_le_read_white_list_size
hci_le_clear_filter_accept_list	hci_le_clear_white_list
hci_le_add_device_to_filter_accept_list	hci_le_add_device_to_white_list
hci_le_remove_device_from_filter_accept_list	hci_le_remove_device_from_white_list
hci_le_read_remote_features	hci_le_read_remote_used_features
hci_le_enable_encryption	hci_le_start_encryption
hci_le_long_term_key_request_negative_reply	hci_le_long_term_key_requested_negative_reply
hci_le_remove_device_from_periodic_advertiser_list	hci_le_remove_device_from_periodic_advertising_list
hci_le_transmitter_test_v2	hci_le_enhanced_transmitter_test
aci_gap_set_security	aci_gap_slave_security_req
	aci_gap_send_pairing_req
aci_gap_add_devices_to_filter_accept_and_resolving_list	aci_gap_add_devices_to_white_and_resolving_list
aci_gap_set_security_requirements	aci_gap_set_authentication_requirement
aci_gap_configure_filter_accept_and_resolving_list	aci_gap_configure_white_and_resolving_list
aci_gap_passkey_resp	aci_gap_pass_key_resp



### 4.2.3 Modified commands

**Table 7. List of commands modified on Bluetooth® LE stack v4.x**

Modified command name (v4.x)	Description
aci_gap_init	Removed five parameters not directly used by the Bluetooth® LE stack library
aci_gatt_clt_prepare_write_req	Added CID parameter to support both unenhanced and enhanced channels.
aci_gatt_clt_execute_write_req	
aci_gatt_clt_disc_all_primary_services	
aci_gatt_clt_disc_primary_service_by_uuid	
aci_gatt_clt_find_included_services	
aci_gatt_clt_disc_all_char_of_service	
aci_gatt_clt_disc_char_by_uuid	
aci_gatt_clt_disc_all_char_desc	
aci_gatt_clt_read	
aci_gatt_clt_read_using_char_uuid	
aci_gatt_clt_read_long	
aci_gatt_clt_read_multiple_char_value	
aci_gatt_clt_write_without_resp	
aci_gatt_clt_confirm_indication	
aci_gatt_srv_notify	
aci_gatt_srv_multi_notify	
aci_gatt_srv_resp	
aci_gatt_clt_write	
aci_gatt_clt_write_long	
aci_gatt_clt_write_char_reliable	
aci_gatt_clt_write_nwk <sup>(1)</sup>	
aci_gatt_clt_write_long_nwk <sup>(1)</sup>	
aci_gatt_clt_write_char_reliable_nwk <sup>(1)</sup>	
aci_gatt_srv_exec_write_resp_nwk <sup>(1)</sup>	
aci_gatt_srv_authorize_resp_nwk <sup>(1)</sup>	

1. Commands available on network coprocessor framework.

**Table 8. List of specific command parameter names modified on Bluetooth® LE stack v4.x**

Command	New parameter name (v4.x)	Parameter name (v3.x)
hci_le_create_connection	Connection_Interval_Min	Conn_Interval_Min
	Connection_Interval_Max	Conn_Interval_Max
	Max_Latency	Conn_Latency
hci_le_connection_update	Connection_Interval_Min	Conn_Interval_Min
	Connection_Interval_Max	Conn_Interval_Max
	Max_Latency	Conn_Latency
	Min_CE_Length	Minimum_CE_Length
	Max_CE_Length	Maximum_CE_Length

Command	New parameter name (v4.x)	Parameter name (v3.x)
hci_le_extended_create_connection	Initiator_Filter_Policy	Initiating_Filter_Policy
hci_le_periodic_advertising_create_sync	Advertiser_Address_Type	Advertising_Address_Type
aci_l2cap_connection_parameter_update_req	Connection_Interval_Min	Conn_Interval_Min
	Connection_Interval_Max	Conn_Interval_Max
	Peripheral_Latency	Slave_Latency
aci_l2cap_connection_parameter_update_resp	Connection_Interval_Min	Conn_Interval_Min
	Connection_Interval_Max	Conn_Interval_Max
	Peripheral_Latency	Slave_Latency
aci_gap_init	-	Role
	Privacy_Type	Privacy_Type
	Device_Name_Char_Len	Device_Name_Char_Len
	-	Identity_Address_Type
	-	Service_Handle
	-	Dev_Name_Char_Handle
aci_gap_start_connection_update	Connection_Interval_Min	Conn_Interval_Min
	Connection_Interval_Max	Conn_Interval_Max
	Max_Latency	Conn_Latency
	Min_CE_Length	Minimum_CE_Length
	Max_CE_Length	Maximum_CE_Length
aci_gap_set_connection_configuration	Connection_Interval_Min	Conn_Interval_Min
	Connection_Interval_Max	Conn_Interval_Max
	Max_Latency	Conn_Latency
	Min_CE_Length	Minimum_CE_Length
	Max_CE_Length	Maximum_CE_Length

#### 4.2.4 Removed commands

**Table 9. List of commands removed on Bluetooth® LE stack v4.x**

Removed command name (v4.x)	Reason
aci_gap_set_event_mask	Not required/used.
aci_gap_set_periodic_advertising_configuration	These GAP commands to handle periodic advertising were simply wrappers of corresponding and standard HCI commands on Bluetooth® LE stack v3.x.
aci_gap_set_periodic_advertising_enable	
aci_gap_periodic_advertising_create_sync	
aci_gap_periodic_advertising_create_sync_cancel	
aci_gap_periodic_advertising_terminate_sync	
aci_gap_add_device_to_periodic_advertiser_list	
aci_gap_remove_device_from_periodic_advertising_list	
aci_gap_clear_periodic_advertiser_list	
aci_gap_read_periodic_advertiser_list_size	
aci_gap_set_periodic_advertising_receive_enable	
aci_gap_periodic_advertising_sync_transfer	

Removed command name (v4.x)	Reason
aci_gap_periodic_advertising_set_info_transfer	These GAP commands to handle periodic advertising were simply wrappers of corresponding and standard HCI commands on Bluetooth® LE stack v3.x.
aci_gap_set_periodic_advertising_sync_transfer_parameters	
aci_gap_set_default_periodic_advertising_sync_transfer_parameters	
aci_gap_set_periodic_advertising_data, aci_gap_set_periodic_advertising_data_nwk <sup>(1)</sup>	
aci_gatt_srv_init	Moved to GATT profile managed externally to the Bluetooth® LE stack v4.x (aci_gatt_srv_profile_init).
aci_gatt_eatt_srv_init	Specific GATT commands for EATT channels are replaced by corresponding GATT commands that have been modified by adding the CID parameter.
aci_gatt_eatt_clt_prepare_write_req	
aci_gatt_eatt_clt_execute_write_req	
aci_gatt_eatt_clt_disc_all_primary_services	
aci_gatt_eatt_clt_disc_primary_service_by_uuid	
aci_gatt_eatt_clt_find_included_services	
aci_gatt_eatt_clt_disc_all_char_of_service	
aci_gatt_eatt_clt_disc_char_by_uuid	
aci_gatt_eatt_clt_disc_all_char_desc	
aci_gatt_eatt_clt_read	
aci_gatt_eatt_clt_read_using_char_uuid	
aci_gatt_eatt_clt_read_long	
aci_gatt_eatt_clt_read_multiple_char_value	
aci_gatt_eatt_clt_write_without_resp	
aci_gatt_eatt_clt_confirm_indication	
aci_gatt_eatt_srv_notify	
aci_gatt_eatt_srv_multi_notify	
aci_gatt_eatt_clt_read_multiple_var_len_char_value	
aci_gatt_eatt_srv_resp	
aci_gatt_eatt_clt_write	
aci_gatt_eatt_clt_write_long	
aci_gatt_eatt_clt_write_char_reliable	
aci_gatt_eatt_clt_write_nwk <sup>(1)</sup>	
aci_gatt_eatt_clt_write_long_nwk <sup>(1)</sup>	
aci_gatt_eatt_clt_write_char_reliable_nwk <sup>(1)</sup>	
aci_gatt_eatt_srv_exec_write_resp_nwk <sup>(1)</sup>	
aci_gatt_eatt_srv_authorize_resp_nwk <sup>(1)</sup>	
aci_l2cap_cfc_connection_req_nwk <sup>(1)</sup>	Specific new l2cap cos commands have been added.
aci_l2cap_cfc_connection_resp_nwk <sup>(1)</sup>	
aci_l2cap_send_flow_control_credits <sup>(1)</sup>	
aci_l2cap_transmit_sdu_data_nwk <sup>(1)</sup>	
aci_l2cap_ecfc_connection_req	
aci_l2cap_ecfc_connection_resp	
aci_l2cap_ecfc_reconfigure_req	

Removed command name (v4.x)	Reason
aci_l2cap_ecfc_reconfigure_resp	Specific new l2cap cos commands have been added.
aci_gap_allow_rebond	Discontinued

1. Commands available on network coprocessor framework.

## 4.3 Bluetooth® LE stack v4.x events

### 4.3.1 New events

The following new events in Table 10 have been defined as required by the new periodic advertising with responses feature.

**Table 10.** List of HCI events related to PAwR feature added by Bluetooth® LE stack v4.x

Event name (v4.x)	Short description
hci_le_periodic_advertising_subevent_data_request_event	See <i>Bluetooth Spec v.5.4, Vol. 4, Part E, HCI, Sec. 7.7</i>
hci_le_periodic_advertising_response_report_event	
hci_le_periodic_advertising_sync_established_v2_event	
hci_le_periodic_advertising_report_v2_event	
hci_le_periodic_advertising_sync_transfer_received_v2_event	
hci_le_periodic_advertising_subevent_data_request_event	
hci_le_periodic_advertising_response_report_event	
hci_le_enhanced_connection_complete_v2_event	
aci_hal_pawr_data_free_event	A new event used to notify the application when the stack has released the previously provided periodic advertising with responses subevent data pointer or response data pointer.
aci_gap_pairing_event	This new event is generated when a pairing process is started.

### 4.3.2 Modified events

**Table 11. List of events modified from Bluetooth® LE stack v4.x**

Modified event name (v4.x)	Details
aci_gatt_srv_attribute_modified_event	Added CID parameter to support both unenhanced and enhanced channels.
aci_gatt_clt_notification_event	
aci_gatt_srv_read_event	
aci_gatt_srv_write_event	
aci_att_srv_prepare_write_req_event	
aci_gatt_proc_timeout_event	
aci_att_exchange_mtu_resp_event	
aci_att_clt_find_info_resp_event	
aci_att_clt_find_by_type_value_resp_event	
aci_att_clt_read_by_type_resp_event	
aci_att_clt_read_resp_event	
aci_att_clt_read_blob_resp_event	
aci_att_clt_read_multiple_resp_event	
aci_att_clt_read_by_group_type_resp_event	
aci_att_clt_prepare_write_resp_event	
aci_att_clt_exec_write_resp_event	
aci_gatt_clt_indication_event	
aci_gatt_clt_proc_complete_event	
aci_gatt_clt_error_resp_event	
aci_gatt_clt_disc_read_char_by_uuid_resp_event	
aci_gatt_srv_confirmation_event	
aci_att_srv_exec_write_req_event	
aci_gatt_srv_authorize_nwk_event	
aci_att_clt_read_multiple_var_len_resp_event	

**Table 12. List of specific event parameter names modified on Bluetooth® LE stack v4.x**

Command	New parameter name (v4.x)	Parameter name (v3.x)
hci_le_connection_complete_event	Connection_Interval	Conn_Interval
	Peripheral_Latency	Conn_Latency
	Central_Clock_Accuracy	Master_Clock_Accuracy
hci_le_connection_update_complete_event	Connection_Interval	Conn_Interval
	Peripheral_Latency	Conn_Latency
hci_le_enhanced_connection_complete_event	Connection_Interval	Conn_Interval
	Peripheral_Latency	Conn_Latency
	Central_Clock_Accuracy	Master_Clock_Accuracy
aci_gap_passkey_req_event	New parameter: Display_Input	-
	New parameter: uint16_t CID	-
aci_att_exchange_mtu_resp_event	MTU	Server_RX_MTU

Command	New parameter name (v4.x)	Parameter name (v3.x)
aci_l2cap_connection_update_req_event	Connection_Interval_Min	Interval_Min
	Connection_Interval_Min	Interval_Min
	Max_Latency	Slave_Latency

### 4.3.3

### Removed events

**Table 13.** List of events removed from Bluetooth® LE stack v4.x

Removed event name (v4.x)	Reason
aci_gap_peripheral_security_initated_event	Discontinued event
aci_gap_bond_lost_event	Replaced by new event aci_gap_pairing_event
aci_gatt_eatt_srv_attribute_modified_event	These events are covered by aci_att*, aci_gatt* events with new CID parameter.
aci_gatt_eatt_proc_timeout_event	
aci_eatt_clt_find_info_resp_event	
aci_eatt_clt_find_by_type_value_resp_event	
aci_eatt_clt_read_by_type_resp_event	
aci_eatt_clt_read_resp_event	
aci_eatt_clt_read_blob_resp_event	
aci_eatt_clt_read_multiple_resp_event	
aci_eatt_clt_read_by_group_type_resp_event	
aci_eatt_clt_prepare_write_resp_event	
aci_gatt_eatt_clt_indication_event	
aci_gatt_eatt_clt_notification_event	
aci_gatt_eatt_clt_proc_complete_event	
aci_gatt_eatt_clt_error_resp_event	
aci_gatt_eatt_clt_disc_read_char_by_uuid_resp_event	
aci_gatt_eatt_srv_confirmation_event	
aci_eatt_srv_exec_write_req_event	
aci_gatt_eatt_srv_authorize_nwk_event	
aci_eatt_clt_read_multiple_var_len_resp_event	

#### 4.3.4 Renamed events

**Table 14. List of events renamed from Bluetooth® LE stack v4.x**

Event name (v4.x)	Event name (v3.x)
hci_le_read_remote_features_complete_event	hci_le_read_remote_used_features_complete_event
hci_le_directed_advertising_report_event	hci_le_direct_advertising_report_event
aci_gap_passkey_req_event	aci_gap_pass_key_req_event
aci_l2cap_cos_disconnection_complete_event	aci_l2cap_disconnection_complete_event
aci_l2cap_cos_flow_control_credit_event	aci_l2cap_flow_control_credit_event
aci_l2cap_cos_sdu_data_tx_event	aci_l2cap_sdu_data_tx_nwk_event
aci_l2cap_cos_sdu_data_rx_nwk_event	aci_l2cap_sdu_data_rx_nwk_event

#### 4.4 Bluetooth® LE stack v4.1 configuration steps

When moving to Bluetooth® LE stack v4.1 from Bluetooth® LE stack v4.0x, user should also take in account the following steps:

1. Add new Bluetooth® LE stack initialization parameter ExtraLLProcedureContexts as described on [Table 2. Bluetooth® LE stack initialization parameters](#). This parameter is handled through CubeMX tool and generated on related app\_conf.h and app\_ble.c files.
2. Add new RADIO interrupt handler RADIO\_RRM\_IRQHandler(void), associated to RADIO\_RRM\_IRQn interrupt line, and define a HAL\_RADIO\_RRMCallback() function which calls BLE\_STACK\_RRMHandler(). All the necessary code is generated by CubeMX within the related files: stm32wb0x\_it.c, stm32wb0x\_it.h, stm32wb0x\_al\_msp.c, app\_ble.c and startup files.

**Note:** When moving from Bluetooth® LE stack v3.x to Bluetooth® LE stack v4.1 user should also apply all the steps previously described related to the migration to Bluetooth® LE stack v4.0x.

## 5 Bluetooth® LE stack v4.x vs v3.x security framework

The following section describes the key security changes available within the Bluetooth® LE stack v4.x in terms of commands and events when compared with Bluetooth® LE stack v3.x.

### 5.1 aci\_gap\_set\_security\_requirements()

It replaces the aci\_gap\_set\_authentication\_requirement() available on Bluetooth® LE stack v3.x.

```
aci_gap_set_security_requirements(
    Bonding_Mode,
    MITM_Mode,
    SC_Support,
    KeyPress_Notification_Support,
    Min_Encryption_Key_Size,
    Max_Encryption_Key_Size,
    Pairing_Response
)
```

#### Description

This command shall be given to set security requirements at device level.

These security requirements are used only when responding to an incoming peripheral security request or pairing request received from a peer device.

If the command is given during pairing, the command returns BLE\_STATUS\_NOT\_ALLOWED.

#### Removed parameters

Use\_Fixed\_Pin  
Fixed\_Pin

#### New parameters

Pairing\_Response:

- If set to 0 (pairing response not required)  
Pairing is always accepted even for bonded devices, and no user interaction is required, since the response is automatically handled by the stack library.
- If set to 1 (pairing response required for bonded devices only)  
The pairing is always automatically accepted (no user interaction) except when the request comes from an already bonded device; in this case aci\_gap\_pairing\_event is always notified, and the explicit pairing response is required (a sort of confirmation of rebonding; this mode is a replacement of the former bond lost event requiring explicit allow rebond command from the user).
- If set to 2 (explicit pairing response)  
A pairing response is always required since aci\_gap\_pairing\_event is always notified to the end-user when a pairing request from a Central or a peripheral security request from a peripheral is received.

**Note:** MITM mode parameter indicates the requirement to achieve MITM protection (that is, an authenticated security level); it is used when responding to an incoming peripheral security request or pairing request received from a peer device.

However, this parameter is not used when actively sending a pairing request or peripheral security request, since in these cases the MITM\_mode bit declared into the authentication requirement field of the two aforementioned PDUs is derived from the security level parameter of the aci\_gap\_set\_security.

This has an implication on how MITM is handled (that is “mandated” referring to the known MITM\_Mandates requirement) at device level, because the MITM mandates is handled by referring to the requirements set into the security request and not to this parameter set at device level.



### Returned values

- BLE\_STATUS\_SUCCESS - security requirements set without any error.
- BLE\_STATUS\_INVALID\_PARAMS - some of the parameters are out of admitted range, according to BT specification, or custom API specification (Bonding and MITM values may be only 0 or 1, as well as KeyPress\_Notification\_Support; encryption key size value shall be in the range [0x07, 0x10], whereas the vendor specific pairing response mode may be equal to 0 or 1 or 2).
- BLE\_ERROR\_UNSUPPORTED\_FEATURE - when KeyPress\_Notification\_Support is set to 1 but a secure connection feature is not supported (that is, excluded through modularity options).

## 5.2

### aci\_gap\_set\_security()

It replaces the aci\_gap\_peripheral\_security\_request() available on Bluetooth® LE stack v3.x.

```
aci_gap_set_security(
    Connection_Handle,
    Security_Level,
    Force_Pairing
)
```

### Description

A new unique command that shall be used to start a pairing procedure starting from BLEPS v4.0 and valid for both security roles Central-Initiator (CEI) and Peripheral-Responder (PER).

When submitted, and following the preliminary consistency checks, the following actions occur with respect to the peer device identified through the connection handle parameter:

- The device acting in the CEI role sends a pairing request.
- The device acting as the PER sends a peripheral security request.

Note:

- *This command replaces the following two commands existing in prior Bluetooth® LE stack v3.x:*
  - aci\_gap\_peripheral\_security\_request;
  - aci\_gap\_send\_pairing\_req.
- *This new command also brings a new parameter that does not exist in the two replaced commands, and that represents the minimum security level to be achieved.*
- *When submitted to a device acting as CEI, this command just enables encryption on the link if the peer is bonded with at least the specified security level, otherwise, it starts a pairing with the peer device.*

### Parameters

Security\_Level: indicates the minimum security level to be achieved.

- No security (no authentication and no encryption)
- Unauthenticated pairing with encryption
- Authenticated pairing with encryption
- Authenticated LE secure connections pairing with encryption using a 128-bit strength encryption key.

Force\_Pairing (valid in case of Central device only).

- The bit b0 indicates whether a pairing request has to be sent (forced) in case the peer device was previously paired/bonded.
- The bit b1 indicates whether the link has to be reencrypted after the key exchange.

### Returned values

- BLE\_STATUS\_SUCCESS - the security procedure (pairing) successfully initiated or the requested security level is already in place with the peer device (for example, requesting security Level 3 when the connection is already secured at level 3 because of previous pairing).
- BLE\_STATUS\_UNKNOWN\_CONNECTION\_ID - the connection handle specified is unknown or not valid.
- BLE\_STATUS\_INVALID\_PARAMS when requested Security\_Level parameter is invalid (<1 or >4) or Force\_Pairing parameter value is invalid (>3).
- BLE\_STATUS\_DEV\_IN\_BLACKLIST - peer device temporarily locked in rejectlist because of previous pairing failure.

- BLE\_STATUS\_NOT\_ALLOWED - current device status does not permit to start the pairing security procedure (for example, another pairing is pending with the same peer device, a peripheral security request is already pending with the same peer device, an encryption key refresh procedure is ongoing with the same peer device, or the initiator device is already serving a peripheral security request from the same peer device).
- BLE\_ERROR\_CONTROLLER\_BUSY - the PKA resource is temporarily busy with another pairing procedure.
- BLE\_STATUS\_SECURITY\_REQUIREMENTS\_NOT\_ACHIEVABLE - current I/O capability settings do not enable to achieve the requested security level. For example, when requesting security Level 3 or 4 with just NoInput-NoOutput capabilities, or Level 4 with no SC support or encryption key size <16 octets.
- BLE\_ERROR\_HOST\_BUSY\_PAIRING - a maximum number of simultaneous pairing procedures supported has been achieved or SC pairing is requested when another SC pairing procedure is still ongoing.
- BLE\_STATUS\_INSUFFICIENT\_RESOURCES - no free Tx packets in the SM Tx pool list to send the request.
- BLE\_STATUS\_FAILED - in case of failure when sending out the packet.

### 5.3

#### aci\_gap\_pairing\_resp()

It is a new command available on Bluetooth® LE stack v4.x.

```
aci_gap_pairing_resp(
    Connection_Handle,
    Accept
)
```

##### Description

This command shall be given in response to an aci\_gap\_paring\_event, to allow or reject either the pairing request from the Central or the security request from the peripheral.

##### Parameters

Accept:

- 0 to REJECT;
- 1 to ACCEPT.

##### Effects

Effects when this command is submitted with Accept = 0 (that is, when pairing is rejected):

- On both Central and peripheral devices:
  - Pairing failed message is sent to the peer device with reason code = 0x05 pairing not supported.

Effects when this command is submitted with Accept = 1 (that is, when pairing is accepted):

- On a Central device: it triggers the sending of a PAIRING REQUEST PDU.
- On a peripheral device: it triggers the sending PAIRING RESPONSE PDU.

##### Return

- BLE\_STATUS\_SUCCESS - in case of successful response sent.
- BLE\_STATUS\_UNKNOWN\_CONNECTION\_ID - the connection handle specified is unknown or not valid.
- BLE\_STATUS\_INVALID\_PARAMS - when Accept parameter value is invalid (>1).

### 5.4

#### aci\_gap\_pairing\_event()

It is a new command available on Bluetooth® LE stack v4.x.

```
aci_gap_pairing_event(
    Connection_Handle,
    Bonded
)
```

### Description

This event is generated when a pairing process is started, and specifically when:

- CEI receives a security request from a PER, or
- PER receives a pairing request from the CEI.

The application shall respond with `aci_gap_pairing_resp` command to accept or reject the incoming pairing procedure notified through this event.

If the pairing is going to start with a nonbonded device, the bonded parameter is cleared. Instead, if the pairing process is going to start with an already bonded device, the event is raised with the bonded parameter set. This may happen either if the peer has lost the bond or if it is a malicious device.

If the `aci_gap_set_security_requirements` command was given with `Pairing_Response` set (pairing confirmation only for bonded devices), the event is raised only if pairing is going to be initiated with a bonded device.

### Parameters

Bonded:

- 0: indicates that the peer device is not already bonded;
- 1: indicated that the peer device is already bonded.

## 5.5

### `aci_gap_passkey_req_event()`

This is a modified event compared to the equivalent event on Bluetooth® LE stack v3.x. A new parameter has been added.

```
aci_gap_passkey_req_event(
    Connection_Handle,
    Display_Input
)
```

### New parameters

Display\_Input:

- 0: A passkey shall be randomly generated and displayed on the device; then it must be provided to the stack through `ACI_GAP_PASSKEY_RESP`.
- 1. A passkey shall be asked of the user, who normally provides it with a keyboard, and provided to the stack through `ACI_GAP_PASSKEY_RESP`.

## Appendix A STSW-BNRGLP-DK vs STM32CubeWB0 software packages

Bluetooth® LE stack v3.x is supported within the STSW-BNRGLP-DK targeting the BlueNRG-LP, BlueNRG-LPS devices while the Bluetooth® LE stack v4.x is supported within the STM32CubeWB0 software packages targeting the STM32WB09xE, STM32WB07xC and STM32WB05xZ devices.

The STM32WB07xC and STM32WB05xZ devices are respectively the rebranded BlueNRG-LP and BlueNRG-LPS devices within the STM32 brand.

The following table provides a comparison about the main characteristics of the STSW-BNRGLP-DK and STM32CubeWB0 software packages.

**Table 15. STSW-BNRGLP-DK and STM32CubeWB0 software packages**

What	STSW-BNRGLP-DK	STM32CubeWB0
Supported devices	BlueNRG-LP and BlueNRG-LPS	STM32WB09xE, STM32WB05xZ (BlueNRG-LPS), STM32WB07xC (BlueNRG-LP)
Software package structure	Application, Docs, Drivers, Firmware, Middleware, Projects, Utilities	Same as standard STM32Cube software packages: Documentation, Drivers, Firmware, Middleware, Projects, Utilities
LL, HAL drivers	LL & HAL drivers but with different naming convention and prefix ( <b>rf_driver_</b> ). 2.4 GHz LL/HAL drivers are included.	LL & HAL drivers with the same structure and naming convention as standard STM32Cube software packages. 2.4 GHz HAL radio driver is included inline with the STM32Cube standard framework
CMSIS	Standard CMSIS files	Standard CMSIS files
BSP	Folders and files for STEVAL-IDB011V1 (BlueNRG-LP) and STEVAL-IDB012V1 (BlueNRG-LPS) kits and resources (pressure, accelerometers)	BSP structure as standard STM32Cube software packages targeting NUCLEO-WB09KE, NUCLEO-WB05KZ, and NUCLEO-WB07CC kits.
Middleware	Bluetooth® LE stack v3.2a framework. Centralized drivers for AES, NVM, PKA, RNG, and Bluetooth® LE controller needed by Bluetooth® LE stack	STM32_BLE Bluetooth® LE middleware: Bluetooth® LE stack v4.0 with new events manager and new Bluetooth® LE features (commands and APIs). AES, NVM, PKA, RNG, and Bluetooth® LE controller drivers are moved to the System folder on each STM32_BLE application.
Bluetooth® LE applications	Simple project structure with main.c, rf_device_it.c (irq handler), and specific application specific files: one for GATT database (services and characteristics), and one for the application specific functionality (state machine, Bluetooth® LE commands and events handling, etc.)	STM32_BLE Bluetooth® LE application structure inline with STM32CubeWBA with System folder containing the drivers for AES, NVM, PKA, RNG, and Bluetooth® LE controller needed by Bluetooth® LE stack.

If a user needs to port an application built within the STSW-BNRGLP-DK software package (BlueNRG-LP/BlueNRG-LPS software package) to STM32CubeWB0, the following steps are suggested:

1. Identify the Bluetooth® LE application scenario inline with the application to be ported (only broadcaster, peripheral & GATT server, Central & GATT client, peripheral, Central & GATT client server).

2. Open the STM32CubeMX tool, select the STM32WB0 series device and design the STM32\_BLE application by following the steps described in the document [1]. The user must replicate the same application configurations available on the STSW-BNRGLP-DK Bluetooth® LE application to be ported. The goal is to generate a project software framework providing:
  - a. System initialization and NVIC configuration
  - b. IP drivers initialization (RCC, GPIOs, PKA, RNG, RADIO, RADIO\_TIMER)
  - c. Bluetooth® LE application mode according to the user scenario (only broadcaster, peripheral & GATT server, Central & GATT client, peripheral, Central & GATT client server)
  - d. Bluetooth® LE stack modular configurations
  - e. Bluetooth® LE stack initialization parameters
  - f. Bluetooth® LE application parameters (Tx power, ...)
  - g. Bluetooth® LE application advertising parameters if applicable
  - h. Bluetooth® LE service and characteristics definition if applicable
3. Once the STM32\_BLE user application software framework has been defined, the user can generate the related project by selecting the preferred toolchain (EWARM, Keil®, STM32CubeIDE).
4. As a last step, the user must open the generated project and add the specific application specific parts from the original STSW-BNRGLP-DK Bluetooth® LE application. It is recommended to add code within the USER defined sections supported from STM32CubeMX whenever it is possible (to keep consistency with CubeMX tool and ioc file).
5. Notice that STM32CubeMX generates STM32\_BLE applications with the sequencer utility framework to use the sequencer. As a consequence, the generated code is tailored for using this framework and the user must follow some guidelines to integrate his application on it. Information and guidelines are provided on the online wiki sequencer page [2]. Referenced STM32\_BLE applications on STM32CubeWB0 are using the sequencer.
6. If the user prefers a simplified approach with no sequencer, it is possible to remove the references to the sequencer utility and apply a simple while(1) approach with the user state machine without any task. An application example is provided on the STM32CubeWB0 software package (BLE\_Peripheral\_Lite).

## Revision history

**Table 16. Document revision history**

Date	Version	Changes
24-Jun-2024	1	Initial release.
06-Nov-2024	2	Updated Table 5. List of new vendor-specific commands introduced by Bluetooth® LE stack v4.x
26-Mar-2025	3	<p>Changed "Bluetooth® Low Energy" term to "Bluetooth® LE".</p> <p>Updated:</p> <ul style="list-style-type: none"> <li>Table 5. List of new vendor-specific commands introduced by Bluetooth® LE stack v4.x</li> <li>Table 6. List of commands renamed on Bluetooth® LE stack v4.x vs v3.x</li> <li>Table 7. List of commands modified on Bluetooth® LE stack v4.x</li> <li>Table 9. List of commands removed on Bluetooth® LE stack v4.x</li> </ul> <p>Added:</p> <ul style="list-style-type: none"> <li>Table 8. List of specific command parameter names modified on Bluetooth® LE stack v4.x</li> <li>Table 12. List of specific event parameter names modified on Bluetooth® LE stack v4.x</li> <li>Section 4.3.4: Renamed events</li> </ul>
27-Oct-2025	4	<p>Updated Table 2. Bluetooth® LE stack initialization parameters.</p> <p>Added Section 4.4: Bluetooth® LE stack v4.1 configuration steps .</p>

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